FORM PTO-1595

:ET

U.S. DEPARTMENT OF COMMERCE

1/31/92

	To the Honorable Commissioner of Patents and Trademarks: Please Record the attached original documents or copy thereof.		
	Name of conveying party(ies):	Name and address of receiving party(ies):	
	Hisayoshi Yamoto Hideo Yamanaka	Name: Sony Corporation	
	Yuichi Satou Hajime Yagi	Street Address: 7-35, Kitashinagawa 6-chome,	
	Additional name(s) of conveying party(ies) attached?	Shinagawa-ku, Tokyo, Japan  City: Zip: Zip:	
	3. Nature of conveyance:  ■ Assignment □ Merger □ Security Agreement □ Change of Name □ Other	Additional Name(s) & Address(es) attached □ Yes ■ No	
	Execution Date <u>Feb. 12, 2000; Feb. 13, 2000; Feb. 28, 2000</u>		
	Application (number(s) or patent number(s):  If this document is being filed together with a new application, the execution date of the application is:		
	A. Patent Application No.(s)	B: Patent No.(s)	
	P00,0159 09/486,619		
	Additional numbers attached? □ Yes ■ No		
	Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved 1	
	Hill & Simpson, P.C.	7. Total Fee (37 CFR 3.41)	
!	85th Floor Sears Tower 233 S. Wacker Drive Chicago, IL 60606	<ul><li>Enclosed</li><li>Authorized to be charged to deposit account any Additional fees</li></ul>	
∿_30\5000 12HU	BAZZ 00000029 09486619	8. Deposit Account Number: 08-2290	
°C:581	40.00 DP	(Attach duplicate copy of this page if paying by deposit account)	
!	DO NOT U	DO NOT USE THIS SPACE	
:	9. Statement and signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Michael R. Hull (Reg. No. 35,902) Name of Person Signing Signature Date		
		Total number of pages including cover sheet: 2	
!	Mail documents to be recorded and required cover sheet information to:  Commissioner of Patents and Trademarks  Box Assignments  Washington, D.C. 20231		

**PATENT** REEL: 010808 FRAME: 0931

## ASSIGNMENT

FOR a valuable consideration, the undersigned,

HISAYOSHI YAMOTO, residing at Kanagawa, Japan, HIDEO YAMANAKA residing at Kanagawa, Japan, YUICHI SATOU, residing at Kanagawa, Japan and HAJIME YAGI residing at Kanagawa, Japan

hereby sell, assign and transfer unto Sony Corporation, 7-35 Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan, a Japanese corporation, the whole right, title and interest in and to a certain invention or improvement in

## METHOD OF FORMING SINGLE-CRYSTAL SILICON LAYER AND METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE

disclosed in an application for Letters Patent of the United States, prepared by the firm of Hill & Simpson, A Professional Corporation of Chicago, Illinois, and executed of even date herewith, said application being identified in the office records of said firm as Case No. P00,0159, and in our own records as Case No. S99P0695US00, and in and to the United States Letters Patent therefor, when issued, together with all improvements thereon and betterments thereof, all divisions, continuations and reissues thereof and substitutions of or for said application, and all rights and privileges under the Letters Patent that may be granted therefor, including the right to claim the benefit of an earlier filing date for the same invention in a foreign country.

We hereby authorize and request the Commissioner of Patents to issue the Letters Patent that may be granted for said invention or improvements to said Sony Corporation.

For the same consideration, we hereby agree that we will promptly communicate to the aforesaid assignce or its assigns full and complete information concerning said improvements or betterments of the inventions disclosed in said application, and will cooperate at any time upon request of said assignce or its assigns, at its expense, in the procurement of patent protection to cover the inventions herein assigned and to be assigned, including the execution of new, divisional, continuing and reissue applications; will make all rightful oaths, will testify in any proceedings in the United States Patent Office or in the Courts, and generally will do everything lawfully possible to aid said assignee, its successors, assigns and nominees to obtain, enjoy and enforce proper patent protection for the inventions embraced within the terms of this document.

RECORDED: 05/12/2000

PATENT

REEL: 010808 FRAME: 0932